

### Vishay High Power Products

# FlipKY® Chip Scale Package Schottky Barrier Rectifier, 0.75 A



FlipKY®

# PRODUCT SUMMARY I<sub>F(AV)</sub> 0.75 A V<sub>R</sub> 30 V

#### **FEATURES**

- Ultra low V<sub>F</sub> to footprint area
- Very low profile (< 0.6 mm)</li>
- · Low thermal resistance
- · Supplied tested and on tape and reel



ROHS

#### **APPLICATIONS**

- · Reverse polarity protection
- · Current steering
- · Freewheeling
- Flyback
- Oring

#### **DESCRIPTION**

Vishay's FlipKY® product family utilizes wafer level chip scale packaging to deliver Schottky diodes with the lowest V<sub>F</sub> to PCB footprint area in industry. The three pad 0.9 mm x 1.2 mm devices can deliver up to 0.75 A and occupy only 1.08 mm² of board space. The anode and cathode connections are made through solder bump pads on one side of the silicon enabling designers to strategically place the diodes on the PCB. This design not only minimizes board space but also reduces thermal resistance and inductance, which can improve overall circuit efficiency.

Typical applications include hand-held, portable equipment such as cell phones, MP3 players, bluetooth, GPS, PDAs, and portable hard disk drives where space savings and performance are crucial.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	MAX.	UNITS		
V <sub>RRM</sub>		30	V		
I <sub>F(AV)</sub>	Rectangular waveform	0.75	Δ.		
I <sub>FSM</sub>		190	A		
V <sub>F</sub>	0.75 Apk, T <sub>J</sub> = 125 °C	0.37	V		
T <sub>J</sub>		- 55 to 150	°C		

VOLTAGE RATINGS				
PARAMETER	SYMBOL	FCSP0730TR	UNITS	
Maximum DC reverse voltage	$V_{R}$	30	V	
Maximum working peak reverse voltage	$V_{RWM}$	30	V	

### FCSP0730TR

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ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>PCB</sub> = 127 °C, rectangular waveform		0.75	
Maximum peak one cycle	I <sub>FSM</sub>	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V <sub>RRM</sub> applied	190	А
non-repetitive surge current at 25 °C		10 ms sine or 6 ms rect. pulse		10	
Non-repetitive avalanche energy	E <sub>AS</sub>	$T_J = 25  ^{\circ}\text{C},  I_{AS} = 2.0  \text{A},  L = 5.0  \text{mH}$		5	mJ
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		0.5	А

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
		0.75 A	T <sub>J</sub> = 25 °C	0.43	0.47	V μA
Maximum forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	1.5 A	11=25 0	0.50	0.54	V
See fig. 1	V FM (1)	0.75 A	T <sub>.1</sub> = 125 °C	0.33	0.37	-
		1.5 A	1 IJ = 125 °C	0.43	0.47	
Maximum reverse leakage current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	10	50	μΑ
See fig. 2	'RM \''	T <sub>J</sub> = 125 °C	VR = nateu VR	5	15	mA
Maximum junction capacitance	C <sub>T</sub>	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		-	90	pF
Maximum voltage rate of charge	dV/dt	Rated V <sub>R</sub>		-	10 000	V/µs

#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300  $\mu s,$  duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> <sup>(1)</sup> , T <sub>Stg</sub>		- 55 to 150	°C	
Typical thermal resistance, junction to PCB	R <sub>thJL</sub> (2)	DC operation	35	°C/W	
Typical thermal resistance, junction to ambient	R <sub>thJA</sub>		150	C/VV	

#### Notes

- (1)  $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$  thermal runaway condition for a diode on its own heatsink
- (2) Mounted on minimum footprint PCB



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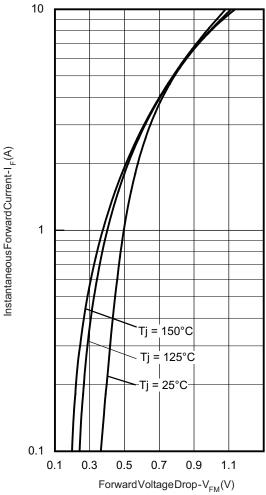


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

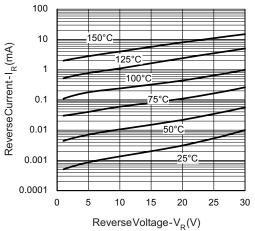


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

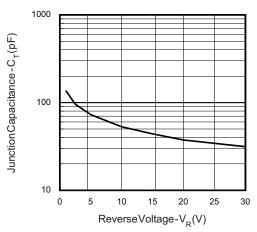


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

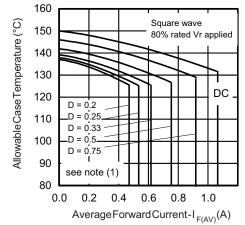


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

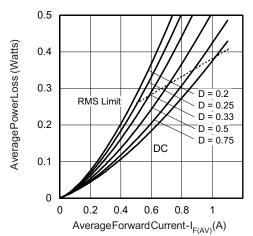


Fig. 5 - Forward Power Loss Characteristics (Per Leg)

#### Note

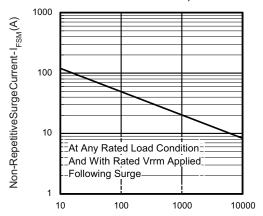
(1) Formula used: T<sub>C</sub> = T<sub>J</sub> - (Pd + Pd<sub>REV</sub>) x R<sub>th,JC</sub>; Pd = Forward power loss = I<sub>F(AV)</sub> x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 6); Pd<sub>REV</sub> = Inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at 80 % V<sub>R</sub> applied

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SquareWavePulseDuration-t<sub>n</sub>(microsec)

Fig. 6 - Maximum Non-Repetitive Surge Current (Per Leg)

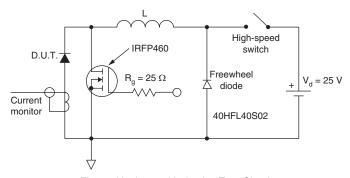


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS				
Dimensions	http://www.vishay.com/doc?95049			
Part marking information	http://www.vishay.com/doc?95060			
Packaging information	http://www.vishay.com/doc?95062			



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